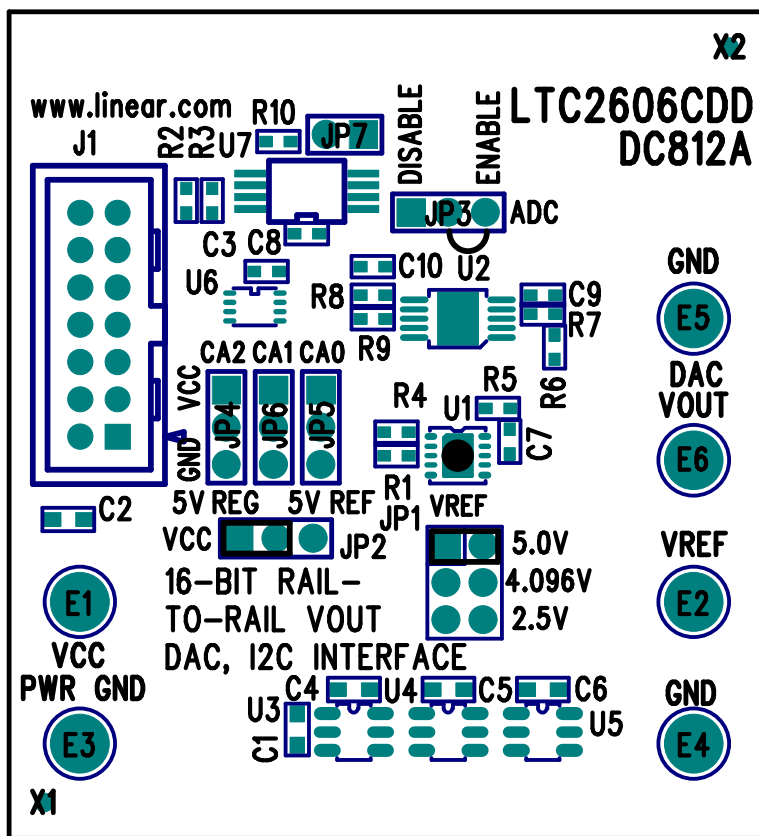


**NOTES: UNLESS OTHERWISE SPECIFIED**

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. INSTALL SHUNTS AS FOLLOWS:  
JP1- PINS 1 & 2  
JP2- PINS 1 & 2  
JP3- PINS 2 & 3
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.  
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.  
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
5. ASSY PROCESSES SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.



# LINEAR TECHNOLOGY CORPORATION

**DC812A REV 2**

## TOP SILKSCREEN

04/14/05